



Attorney's Docket No. 07977/088002/US3155D1 ✓28144

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : H. Zhang Art Unit : 2814
Serial No.: 09/362,808 Examiner : Thanh V. Tran
Filed : July 28, 1999
Title : METHOD OF FABRICATING SEMICONDUCTOR DEVICE

Commissioner for Patents
Washington, D.C. 20231

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TRANSMITTAL LETTER AND PETITION FOR AUTOMATIC EXTENSION

Correspondence relating to this application is enclosed.
The required fees are computed below. Please apply any charges
not covered, or any credits, to Deposit Account No. 06-1050.

Total Claims	40	-	37	=	3	\$54
Independent	6	-	6	=	0	\$0
TOTAL FEE DUE						\$54

A check for \$54 is attached.

Respectfully submitted,

Date: 8/5/08


Scott C. Harris
Reg. No. 32,030

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663-

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CERTIFICATE OF MAILING BY FIRST CLASS MAIL

I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

February 5, 2002

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Susan Regan

Signature

Typed or Printed Name of Person Signing Certificate



Attorney's Docket No.: 07977/088002/US3155D1

#100
R. Brinkman
2/26/2002

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AMENDMENT

Siri:

In response to the Official Action mailed November 5, 2001, Paper No. 9, in the above-referenced application, please amend the above-identified application as follows.

In the Claims:

Please amend claims 1, 2, 10, 14, 19, and 24 as follows:

1. (Amended) A semiconductor device comprising:

a semiconductor having at least channel, source and drain regions;

an insulating film formed on said semiconductor;

a first interlayer insulating film over said insulating film;

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SM Regan

Susan Regan

Typed or Printed Name of Person Signing Certificate